Honeywell Docket No. H0005045 USA - 4018

Buchalter Docket No.: H9925-3505

REMARKS

35 USC §§102 AND 103

Claims 1-6, 10-12, 18-24 and 28-30 are rejected under 35 USC §102(b), as being anticipated

Claims 7 and 25 are rejected under 35 USC 103(a), as being by Vogel et al. (US 6317326).

unpatentable over Vogel et al., as applied to claims 1-6, 10-12, 18-24 and 28-30, in view of Ito et al.

(JP 2000-294699). The Applicant respectfully disagrees, especially in view of the amendments

presented herein.

Claim 1 recites:

A thermal transfer material, comprising:

a heat spreader component, wherein the heat spreader component comprises a top

surface, a bottom surface and at least one heat spreader material and wherein the heat

spreader component comprises a thickness of about 0.25 mm to about 6 mm, and

at least one solder material, wherein the solder material is directly deposited onto

the bottom surface of the heat spreader component.

Claim 19 recites:

A method of forming a thermal transfer material, comprising:

providing a heat spreader component, wherein the heat spreader component

comprises a top surface, a bottom surface and at least one heat spreader

material and wherein the heat spreader component comprises a thickness of about 0.25

mm to about 6 mm;

providing at least one solder material, wherein the solder material is directly

deposited onto the bottom surface of the heat spreader component; and

6

Honeywell Docket No. H0005045 USA - 4018

Buchalter Docket No.: H9925-3505

depositing the at least one solder material onto the bottom surface of the heat

spreader component.

Neither the Vogel nor the Ito reference teach, disclose or suggest to one of ordinary skill in

the art a heat spreader component, wherein the heat spreader component comprises a top surface, a

bottom surface and at least one heat spreader material and wherein the heat spreader component

comprises a thickness of about 0.25 mm to about 6 mm or providing the same heat spreader

component. Therefore, claims 1 and 19 are allowable as patentable and not anticipated by Vogel, Ito

or a combination thereof. In addition, claims 2-7, 9-18, 20-25 and 27-36 are allowable by virtue of

their dependency on claims 1 and 19, respectively.

7

Honeywell Docket No. H0005045 USA - 4018

Buchalter Docket No.: H9925-3505

## **REQUEST FOR ALLOWANCE**

Claims 1-7, 9-25 and 27-36 are pending in this application, and the Applicant respectfully requests that the Examiner reconsider all of the claims in light of the arguments presented and allow all current and pending claims.

Respectfully submitted,

Buchalter Nemer, A Professional Corporation

Dated: 1 22 200 1

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